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To the Honorable Commissioner of Pate 100904919 original documents or copy thereof. Name of conveying party(ies): 2. Name and address of receiving party(ies): John E. Barth Claude L. Bertin Wayne F. Ellis Jeffrey H. Dreibelbis Name: International Business Machines Corporation Wayne J. Howell Erik L. Hedberg Howard L. Kalter William R. Tonti Internal Address: Donald L. Wheater Additional names of conveying party(ies) attached? □ yes □ no 3. Nature of Conveyance New Orchard Road Street Address: City Armonk □ Merger State New York Zip 10504 ☐ Security Agreement ☐ Change of Name □ Other Additional name(s) & address(es) attached? ☐ yes Ø no **Execution Date:** Application number(s) or patent number(s): Title: STRUCTURES FOR WAFER LEVEL TEST AND BURN-IN If this document is being filed together with a new application, the execution date of the application is A. Patent Application No(s). B. Patent No(s). Additional numbers attached? 

Yes 

No 5. Name and address of party to whom correspondence 6. Total number of applications and patents involved: concerning document should be mailed: James M. Leas 7. Total fee (37 CVF 3.41): \$\_40.00 **IBM** Corporation Intellectual Property Law Dept. 972-2E Enclosed 1000 River Road Essex Junction, VT 05452 Authorized to be charged to deposit account Total fee due CERTIFICATE OF MAILING UNDER 37 CFR 1.10 I hereby certify that, on the date shown below, this correspondence is being deposited with the United States Postal Service in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231, as "Express Mail EL046617465US 8. Deposit account number: 09-0456 09191954 DO NOT USE THIS SPACE 01 FC:861 <del>40.00 CH</del> Statement and signature To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. James M. Leas Name of Person Signing Signature Date Registration # 34,372 Tel.: (802) 769/9824 Total number of pages comprising cover sheet:

REEL: 9587 FRAME: 0724

(IBM Docket No.: BU9-97-214

## **ASSIGNMENT**

## Whereas, we

Inventor and City	(1) John E. Barth $\mathcal{F}r$ $\mathcal{H}s$ County of Chittenden	City of Williston and State of Vermont
and	(2) Claude L. Bertin County of Chittenden	City of So. Burlington and State of Vermont
	County of Cinteriden	and State of Vermont
and	(3) Jeffrey H. Dreibelbis	City of Williston
	County of Chittenden	and State of Vermont
and	(4) Wayne F. Ellis	City of Jericho
	County of Chittenden	and State of Vermont
and	(5) Wayne J. Howell	City of Williston
	County of Chittenden	and State of Vermont
and	(6) Erik L. Hedberg	City of Essex Junction
	County of Chittenden	and State of Vermont
and	(7)Howard L. Kalter	City of Colchester
	County of Chittenden	and State of Vermont
and	(8) William R. Tonti	City of Essex Junction
	County of Chittenden	and State of Vermont
and	(9) Donald L. Wheater	City of Hinesburg
	County of Chittenden	and State of Vermont

have invented certain improvements in Title: STRUCTURES FOR WAFER LEVEL TEST AND BURN-IN

Dates That Inventors Signed the Declaration and have executed, respectively, a United States patent application therefor on

(1) [1]/3	1998, and (2) ∃3 No√	1998, and
(3) /1/13	1998, and (4) ∤:↓↓ 3	1998, and
(5) 11 7,3	1998, and (6) ////3	1998, and
(7) 11/13	1998, and (8)///3	1998, and
(9) 11/13	1998.	•

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we the above named hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

City	(1) Signed at $Esscx$	Junction,	Vermont,	
Date	on 11 13/98	,	Sohn E. First Name Middle Initial	signature Barth Jr. ) inventor Last Name

Page 1 of 2

City	(2) Signed at Essen Junction, VT	APA .	, 2	1	
Date	on 13 Nov 1998	Claude First Name	. Delo L. Middle Initial	Bertin Last Name	signature ) inventor
City	(3) Signed at ESSEX Jun Tien, VT		· · ·	. 1	
Date	on "/13/98	( Jeffrey First Name	- Lienbel H. Middle Initial	Dreibelbis Last Name	_ signature ) inventor
City	(4) Signed at ESSRX Junction V+	. //	1 1/	2/1.	
Date	on 11/13/98	(Wayne) First Name	F. Middle Initial	Ellis Last Name	signature ) inventor
City	(5) Signed at Essay Junitury, VT.	<i>/</i> )	1 - 1	. 1	
Date	on 11/13/98	(Wayne) First Name	Middle Initial	Howell Last Name	signature )inventor
City	(6) Signed at Cosex Junction, VI	CIA	1/ 1/1		
Date	on 11/13/98	(Erik First Name	L. Middle (nitial	Hedberg Last Name	signature )inventor
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Date	on 11/13/48	(Howard First Name	L. Middle Initial	Kalter Last Name	<u>sig</u> nature )inventor
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Date	on 11113/98	(William First Name	R. Middle Initial	Tonti Last Name	signature )inventor
City	(9) Signed at Essex Jet 14	() 11	/		
Date	on 11/13/98	(Donald First Name	L. Middle Initial	<del>_</del>	ignature ) inventor